

## PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
<b>CONVEYING PARTY DATA</b>													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yoshikazu NAKAMURA</td> <td>01/11/2012</td> </tr> <tr> <td>Ling JIN</td> <td>01/10/2012</td> </tr> <tr> <td>Satoko YAMAZAKI</td> <td>01/10/2012</td> </tr> <tr> <td>Hisako IKEDA</td> <td>01/10/2012</td> </tr> <tr> <td>Masahiro MURAGUCHI</td> <td>01/30/2012</td> </tr> </tbody> </table>		Name	Execution Date	Yoshikazu NAKAMURA	01/11/2012	Ling JIN	01/10/2012	Satoko YAMAZAKI	01/10/2012	Hisako IKEDA	01/10/2012	Masahiro MURAGUCHI	01/30/2012
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Masahiro MURAGUCHI	01/30/2012												
<b>RECEIVING PARTY DATA</b>													
Name:	RIBOMIC INC.												
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City:	Tokyo												
State/Country:	JAPAN												
Postal Code:	101-8535												
<b>PROPERTY NUMBERS Total: 1</b>													
Property Type	Number												
Application Number:	13377201												
<b>CORRESPONDENCE DATA</b>													
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OP \$40.00 13377201

Correspondent Name: WENDEROTH, LIND & PONACK, LLP  
Address Line 1: 1030 15th Street, N.W.  
Address Line 2: Suite 400 East  
Address Line 4: Washington, DISTRICT OF COLUMBIA 20005

ATTORNEY DOCKET NUMBER:	2011_1942A
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NAME OF SUBMITTER:	Donna King
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Total Attachments: 2 source=ASSIGNMENT#page1.tif source=ASSIGNMENT#page2.tif
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# ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) of Inventor(s) Yoshikazu NAKAMURA, Ling JIN, Satoko YAMAZAKI, Hisako IKEDA and Masahiro MURAGUCHI

the undersigned hereby sell(s) and assign(s) to

Insert Name(s) of Assignee(s) RIBOMIC INC. of 16-13, Shirokanedai 3-chome, Minato-ku, Tokyo 108-0071 Japan  
Address and OTSUKA PHARMACEUTICAL CO., LTD. of 9, Kanda-Tsukasamachi 2-chome, Chiyoda-ku, Tokyo 101-8535 Japan

Title of Invention (hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as  
APTAMER FOR CHYMASE, AND USE THEREOF

for which an application for patent in the United States of America has resulted from International Application Serial No. PCT/JP2010/059953 filed on June 11, 2010

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 1030 15th Street, N.W., Suite 400 East Washington, D.C. 20005-1503, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 2012/1/11, Name of the Inventor *Yoshikazu NAKAMURA*  
Yoshikazu NAKAMURA

Date 2012/1/10, Name of the Inventor Ling JIN  
Ling JIN

Date 2012/1/10, Name of the Inventor Satoko Yamazaki  
Satoko YAMAZAKI

Date 2012/1/10, Name of the Inventor Hisako Ikeda  
Hisako IKEDA

Date 2012/1/30, Name of the Inventor Masahiro Muraguchi  
Masahiro MURAGUCHI

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness *Emiko Nakamura*  
Emiko NAKAMURA

Witness *Kazuya Yamaniishi*  
Kazuya YAMANISHI

**ACKNOWLEDGMENT**

\_\_\_\_\_  
\_\_\_\_\_ } ss

This \_\_\_\_\_ day of \_\_\_\_\_, 20\_\_\_\_, before me personally came the above-named me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL \_\_\_\_\_  
Official Signature  
\_\_\_\_\_  
Official Title

The above application may be more particularly identified as follows:  
U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_  
Applicant Reference Number \_\_\_\_\_ Atty Docket No. \_\_\_\_\_  
Title of Invention \_\_\_\_\_